

# HAT2160H

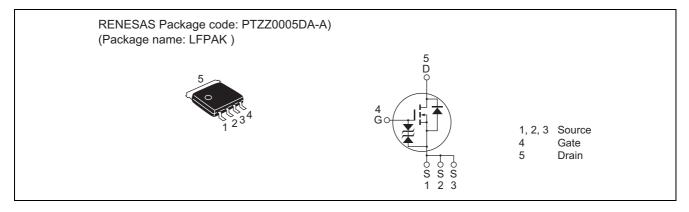
Silicon N Channel Power MOS FET Power Switching

> REJ03G0002-0300 Rev.3.00 Sep 26, 2005

### Features

- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance
- $R_{DS(on)} = 2.1 \text{ m}\Omega \text{ typ.} (at V_{GS} = 10 \text{ V})$

### Outline



### **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	20	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	60	A
Drain peak current	I <sub>D(pulse)</sub> Note1	240	A
Body-drain diode reverse drain current	I <sub>DR</sub>	60	A
Avalanche current	I <sub>AP</sub> Note 3	30	A
Avalanche energy	E <sub>AR</sub> Note 3	90	mJ
Channel dissipation	Pch Note2	30	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu s,\,duty\,cycle \leq$  1%

2.  $Tc = 25^{\circ}C$ 

3. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$ 

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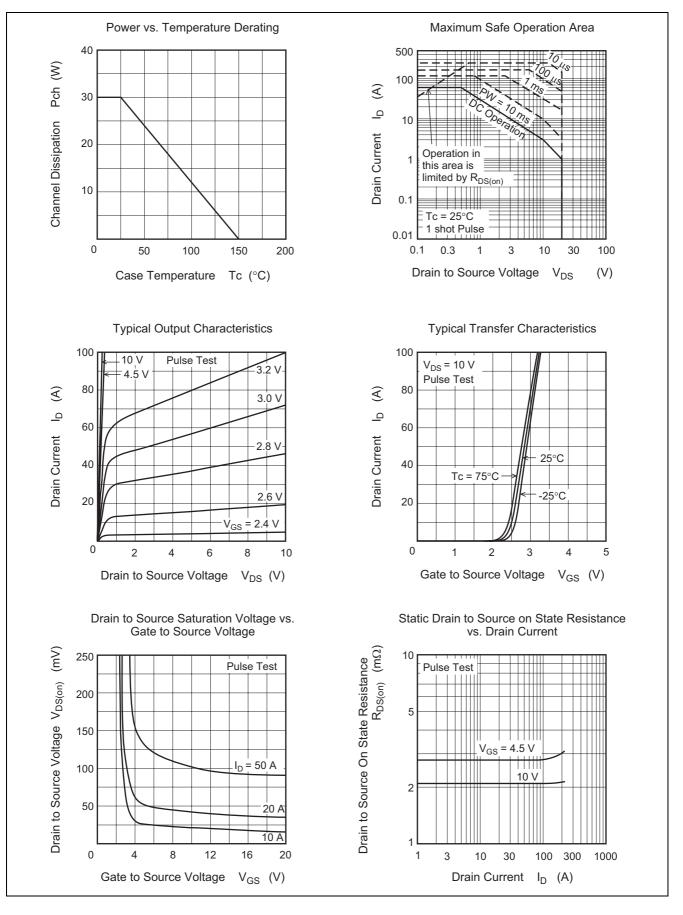
# **Electrical Characteristics**

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	20	_	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±20	—	—	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 20 V, V_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS(off)</sub>	0.8	_	2.3	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Static drain to source on state	R <sub>DS(on)</sub>	_	2.1	2.6	mΩ	$I_D = 30 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R <sub>DS(on)</sub>	_	2.8	4.1	mΩ	$I_D = 30 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note4}$
Forward transfer admittance	y <sub>fs</sub>	78	130	_	S	$I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	7750		pF	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0, f = 1 MHz
Output capacitance	Coss	_	1220	_	pF	
Reverse transfer capacitance	Crss	_	450		pF	
Gate resistance	Rg		0.5		Ω	
Total gate charge	Qg		54		nC	$V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V},$
Gate to source charge	Qgs		19		nC	I <sub>D</sub> = 60 A
Gate to drain charge	Qgd		14		nC	
Turn-on delay time	t <sub>d(on)</sub>		17		ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A},$
Rise time	tr		60		ns	
Turn-off delay time	t <sub>d(off)</sub>		65		ns	
Fall time	t <sub>f</sub>	_	15	—	ns	7
Body-drain diode forward voltage	V <sub>DF</sub>	_	0.82	1.07	V	$IF = 60 A, V_{GS} = 0^{Note4}$
Body-drain diode reverse recovery	t <sub>rr</sub>	_	40		ns	$IF = 60 A, V_{GS} = 0$
time						di <sub>F</sub> / dt = 100 A/ μs

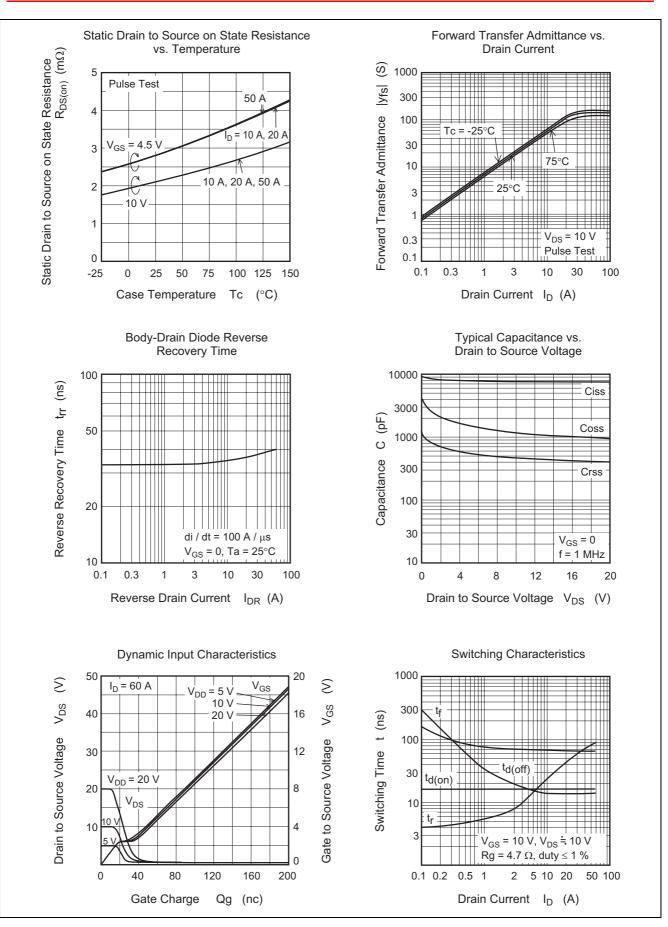
Notes: 4. Pulse test



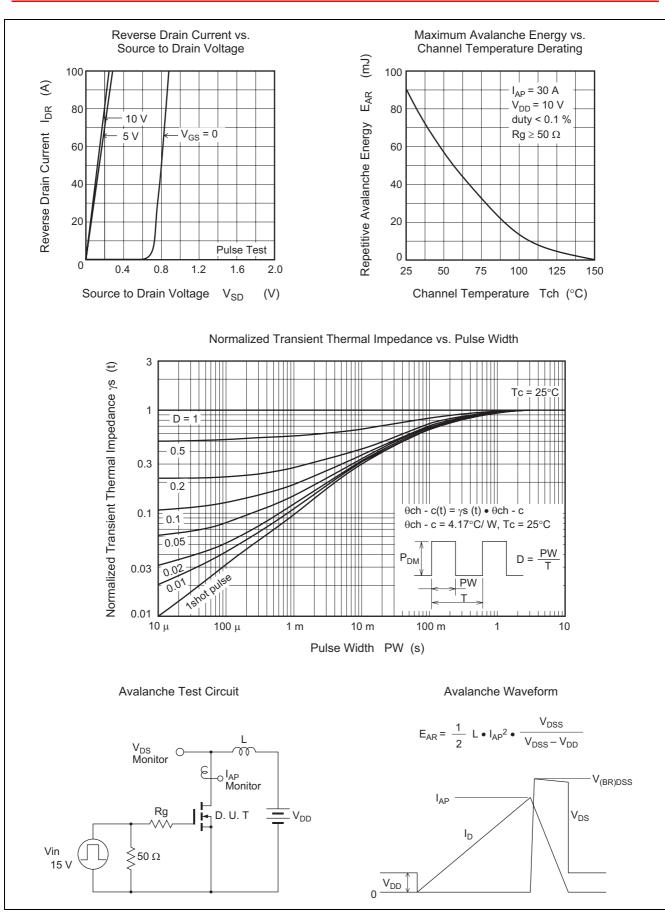
### **Main Characteristics**



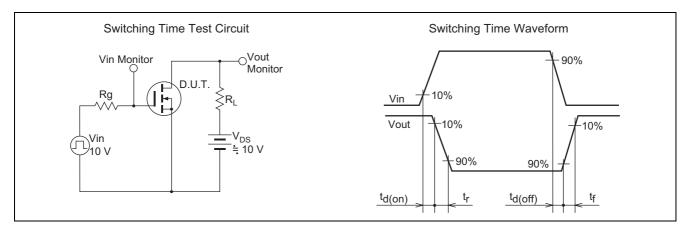






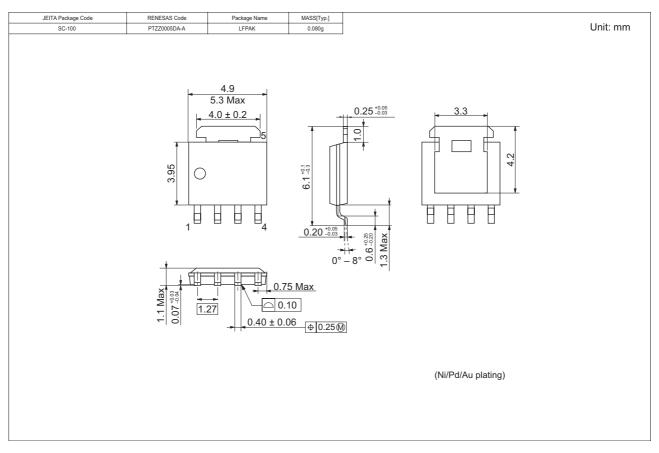








# **Package Dimensions**



# **Ordering Information**

Part Name	Quantity	Shipping Container
HAT2160H-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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